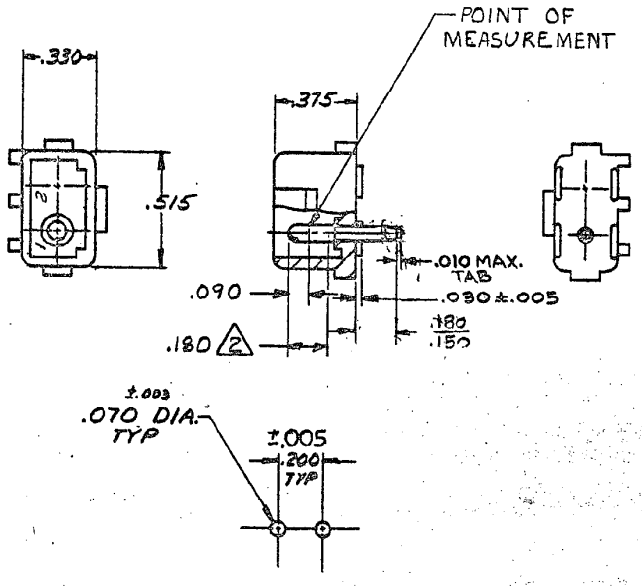

RECOMMENDED LAYOUT FOR .062 THICK P.C. BOARD

1. PARTS COMPLY WITH TE SOLDERABILITY SPEC. NO. 109-11-3
2. CONTACT IS PLATED OVERALL WITH .000050 NICKEL, THEN .000030 GOLD OVER CONTACT LENGTH INDICATED AND TIN PLATED ON SOLDER TAIL END.
3. DIMENSION SHOWN REPRESENT PRODUCT IN DRY CONDITION. ADDITIONAL 2% GROWTH DUE TO END USE LOCATION MOISTURE ABSORPTION MAY OCCUR AND SHOULD BE ACCOUNTED FOR.

WAS P-73-6101

SUPERSEDED BY 1586530-2

	-2	NATURAL	GOLD (2)
6-	-1	- BLUE	- PRE TIN
2-	-1	- RED	
350539-1		NYLON - NATURAL	COPPER ALLOY - PRE-TIN
ASSEMBLY NO.		HSG MATL & COLOR	PIN MATL & FINISH

©1973 BY AMP INCORPORATED. ALL RIGHTS RESERVED.
AMP PRODUCTS COVERED BY PATENTS AND/OR PATENTS PENDING.

CUSTOMER COPY REFERENCE ONLY

DR G. Edson 3-30-73
CHK EM Peterhans 4/9/73
DES J. Kunkle
APP J. Kunkle

MATERIAL AND FINISH: SEE TABLE

TE Connectivity

CLASS: 084 DIA. PIN
TYPE: POSITIVE LOCK
WIRE RANGE — INSULATION
PLATING PER EECT AS NOTED IN .010 / .030 OVER
SCALE: —
LOC CM B
NO 350539
REV N4

2 CIRCUIT MATE-N-LOK P.C. BOARD HEADER

REQUIRED PER ASSEMBLY

DESCRIPTION

NUMBER 350539

LTR	REVISION RECORD	DR	CHK	DATE
N4	REVISED PER ECR-21-117185	PJ	VS	25OCT2021
N3	REVISED PER ECR-18-008156	JB	DZ	19JUN2018
N2	REVISED PER ECR-13-008342	AV	RP	12NOV13
N1	REVISED PER ECO-11-005294	RK	HMR	08APR11

DIMENSIONS IN INCHES. DO NOT SCALE PRINT.